



GUNNISON, MCKAY & HODGSON, L.L.P.

GARDEN WEST OFFICE PLAZA, SUITE 220  
1900 GARDEN ROAD  
MONTEREY, CALIFORNIA 93940  
(831) 655-0880  
FACSIMILE (831) 655-0888

April 25, 2005

Mail Stop Reissue  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**TRANSMITTAL LETTER**

RE: Applicant(s): Won Sun Shin et al.

Assignee: Amkor Technology, Inc.

Title: SEMICONDUCTOR PACKAGE AND METHOD FOR  
FABRICATING THE SAME

Serial No.: 10/825,670 Filed: April 14, 2004

Examiner: Chuong A. Luu Group Art 2818  
Unit:

Docket No.: GK0012RI

Dear Sir:

Transmitted herewith are the following documents for the response to the Office Action dated January 31, 2005 in the above application:

1. Return receipt postcard;
2. Check in the amount of \$180.00 for IDS fee;
3. This Transmittal Letter (2 pages);
4. Response (6 pages);
5. Information Disclosure Statement Under §1.97(c) with Fee (3 pages);
6. PTO Form 1449 (3 pages); and
7. Copy of each non-English document cited (2 total).

Transmittal Letter  
 Serial No. 10/825,670  
 April 25, 2005

- No additional claims fees are required.

CLAIMS AS AMENDED

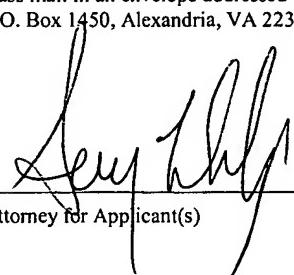
	Claims Remaining after Amendment	Highest No. Previously Paid For	Present Extra	Rate	Additional Fee
Total Claims	35	- 35	= 0	x \$50.00	\$ 0.00
Independent Claims	1	- 1	= 0	x \$200.00	\$ 0.00
First filing of Multiple Dependent Claim (Enter \$290)					0.00
Total of above Calculation					\$0.00
Reduction by 50% for filing by Small Entity (Enter 0.5 for small entity)					1.0
					Subtotal
Submission of Information Disclosure Statement Fee (enter \$180)					\$ 0.00
					180.00
					<b>TOTAL \$ 180.00</b>

A check in the amount of \$ 180.00 is enclosed.

- Conditional Petition for Extension of Time: If an extension of time is required for timely filing of the enclosed documents after all papers filed with this transmittal have been considered, Applicant(s) hereby petition for such an extension of time.
- The Commissioner is hereby authorized to charge any additional fees required for consideration of the enclosed documents, and to credit any overpayment of fees to Deposit Account No. 50-0553.

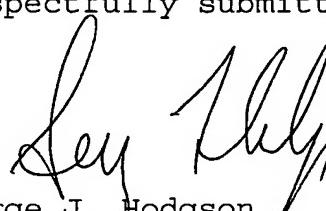
**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on April 25, 2005.

  
 Attorney for Applicant(s)

April 25, 2005  
 Date of Signature

Respectfully submitted,

  
 Serge J. Hodgson  
 Attorney for Applicant(s)  
 Reg. No. 40,017



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Won Sun Shin et al.

Assignee: Amkor Technology, Inc.

Title: SEMICONDUCTOR PACKAGE AND METHOD FOR FABRICATING  
THE SAME

Serial No.: 10/825,670 Filed: April 14, 2004

Examiner: Chuong A. Luu Group Art 2818  
Unit:

Docket No.: GK0012RI

Monterey, CA  
April 25, 2005

Mail Stop Reissue  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT  
UNDER §1.97(c) WITH FEE

Sir:

Pursuant to 37 C.F.R. §§ 1.56, 1.97 and 1.98, Applicant(s) wish to call the following documents (a copy of each non-English document is enclosed) to the attention of the Examiner.

**U.S. PATENT DOCUMENTS**

	DOCUMENT NUMBER	DATE	NAME
1)	4,398,235	08/1983	Lutz et al.
2)	4,729,061	03/1988	Brown
3)	5,241,133	08/1993	Mullen, III et al.
4)	5,394,010	02/1995	Tazawa et al.
5)	5,438,224	08/1995	Papageorge et al.
6)	5,491,612	02/1996	Nicewarner, Jr.
7)	5,594,275	01/1997	Kwon et al.
8)	5,625,221	04/1997	Kim et al.
9)	5,677,569	10/1997	Choi et al.

10)	5,744,827	04/1998	Jeong et al.
11)	5,760,471	06/1998	Fujisawa et al.
12)	5,801,439	09/1998	Fujisawa et al.
13)	5,835,988	11/1998	Ishii
14)	5,866,949	02/1999	Schueller
15)	5,883,426	03/1999	Tokuno et al.
16)	5,986,209	11/1999	Tandy
17)	6,001,671	12/1999	Fjelstad
18)	6,072,233	06/2000	Corisis et al.
19)	6,097,089	08/2000	Gaku et al.
20)	6,180,696	01/2001	Wong et al.
21)	6,313,522	11/2001	Akram et al.
22)	6,326,696	12/2001	Horton et al.
23)	6,395,578	05/2002	Shin et al.
24)	6,396,143	05/2002	Kimbara et al.
25)	6,404,046	06/2002	Glenn et al.
26)	6,459,148	10/2002	Chun-Jen et al.
27)	6,577,013	06/2003	Glenn et al.

#### FOREIGN DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY
1)	KR1996-0009776	4/01/1996	Rep. Of Korea
2)	KR1996-041464	9/21/1996	Rep. Of Korea

#### OTHER DOCUMENTS

1)	Shin et al., U.S. Patent Application Serial No.10/785,528, filed February 24, 2004, entitled "SEMICONDUCTOR PACKAGE AND METHOD FOR FABRICATING THE SAME"
----	--

A PTO form 1449 listing these documents is enclosed. The relevance of the non-English language documents is set forth in the enclosed English translations of the abstracts.

Citation of the above documents shall not be construed as:

1. an admission that the documents are necessarily prior art with respect to the instant invention;

2. a representation that a search has been made, other than as described above; or

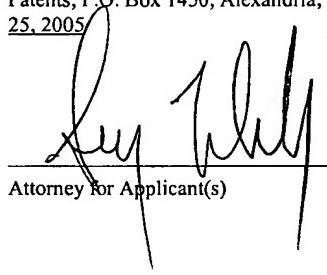
3. an admission that the information cited herein is, or is considered to be, material to patentability as defined in § 1.56(b).

Enclosed herewith is a check in the amount of \$180.00 payable to the Director of the United States Patent and Trademark Office, which is the amount for submission of an Information Disclosure Statement given in 37 C.F.R. § 1.17(p).

The Commissioner is hereby authorized to charge any additional fees, which may be required to consider this paper, or credit any overpayment to Deposit Account No. 50-0553.

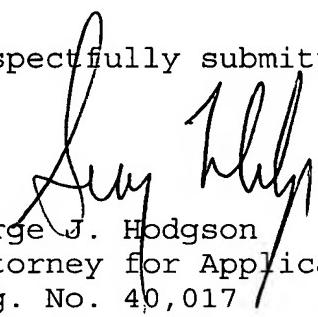
**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on April 25, 2005

  
\_\_\_\_\_  
Attorney for Applicant(s)

\_\_\_\_\_  
April 25, 2005  
Date of Signature

Respectfully submitted,

  
\_\_\_\_\_  
Serge J. Hodgson  
Attorney for Applicant(s)  
Reg. No. 40,017  
(831) 655-0880

<b>Form PTO-1449</b>   <b>INFORMATION DISCLOSURE CITATION</b> <b>IN AN APPLICATION</b>  <i>(Use several sheets if necessary)</i>					Atty Docket No.	Serial No.		
					GK0012RI	10/825,670		
					Applicant(s)			
					Won Sun Shin et al.			
<b>Filing Date</b> April 14, 2004					Group	2818		
<b>U. S. PATENT DOCUMENTS</b>								
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
	AA	4,398,235	08/1983	Lutz et al.	361	393		
	AB	4,729,061	03/1988	Brown	361	386		
	AC	5,241,133	08/1993	Mullen, III et al.	174	52.4		
	AD	5,394,010	02/1995	Tazawa et al.	257	686		
	AE	5,438,224	08/1995	Papageorge et al.	257	777		
	AF	5,491,612	02/1996	Nicewarner, Jr.	361	760		
	AG	5,594,275	01/1997	Kwon et al.	257	686		
	AH	5,625,221	04/1997	Kim et al.	257	686		
	AI	5,677,569	10/1997	Choi et al.	257	686		
	AJ	5,744,827	04/1998	Jeong et al.	257	686		
	AK	5,760,471	06/1998	Fujisawa et al.	257	692		
<b>FOREIGN PATENT DOCUMENTS</b>								
								Translation
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	YES	NO
	AL	KR1996-0009776	4/01/1996	Rep. Of Korea			abst	
	AM	KR1996-041464	9/21/1996	Rep. Of Korea			abst	
	AN							
	AO							
	AP							
<b>OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)</b>								
	AR	Shin et al., U.S. Patent Application Serial No.10/785528, filed February 24, 2004, entitled "SEMICONDUCTOR PACKAGE AND METHOD FOR FABRICATING THE SAME"						
	AS							
	AT							
Examiner			Date Considered					
<b>EXAMINER:</b> Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).								

Form PTO-1449			Atty Docket No. GK0012RI		Serial No. 10/825,670			
INFORMATION DISCLOSURE CITATION IN AN APPLICATION			Applicant(s) Won Sun Shin et al.					
(Use several sheets if necessary)			Filing Date April 14, 2004		Group 2818			
<b>U. S. PATENT DOCUMENTS</b>								
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
	AA	5,801,439	09/1998	Fujisawa et al.	257	686		
	AB	5,835,988	11/1998	Ishii	257	684		
	AC	5,866,949	02/1999	Schueller	257	778		
	AD	5,883,426	03/1999	Tokuno et al.	257	686		
	AE	5,986,209	11/1999	Tandy	174	52.4		
	AF	6,001,671	12/1999	Fjelstad	438	112		
	AG	6,072,233	06/2000	Corisis et al.	257	686		
	AH	6,097,089	08/2000	Gaku et al.	257	712		
	AI	6,180,696	01/2001	Wong et al.	523	457		
	AJ	6,313,522	11/2001	Akram et al.	257	686		
	AK	6,326,696	12/2001	Horton et al.	257	777		
<b>FOREIGN PATENT DOCUMENTS</b>								
							Translation	
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	YES	NO
	AL							
	AM							
	AN							
	AO							
	AP							
<b>OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)</b>								
	AR							
	AS							
	AT							
Examiner		Date Considered						
EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).								

Form PTO-1449			Atty Docket No. GK0012RI	Serial No. 10/825,670
INFORMATION DISCLOSURE CITATION IN AN APPLICATION			Applicant(s) Won Sun Shin et al.	
(Use several sheets if necessary)			Filing Date April 14, 2004	Group 2818

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	AA	6,395,578	05/2002	Shin et al.	438	106	
	AB	6,396,143	05/2002	Kimbara et al.	257	712	
	AC	6,404,046	06/2002	Glenn et al.	257	690	
	AD	6,459,148	10/2002	Chun-Jen et al.	257	692	
	AE	6,577,013	06/2003	Glenn et al.	257	777	
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	YES	NO
	AL								
	AM								
	AN								
	AO								
	AP								

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

	AR	
	AS	
	AT	

Examiner                      Date Considered

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).